

IRFBC30 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number

IRFBC30-DG

Manufacturer

Vishay Siliconix

Manufacturer Product Number

IRFBC30

Description

MOSFET N-CH 600V 3.6A TO220AB

Detailed Description

N-Channel 600 V 3.6A (Tc) 74W (Tc) Through Hole T

O-220AB



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
IRFBC30	Vishay Siliconix
Series:	Product Status:
	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
600 V	3.6A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	2.20hm @ 2.2A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
4V @ 250μA	31 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	660 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	74W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
TO-220AB	TO-220-3
Base Product Number:	
IDEDC20	

Environmental & Export classification

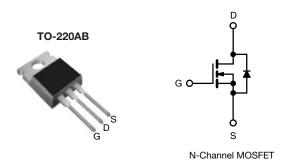
8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



Vishay Siliconix

Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	600			
$R_{DS(on)}(\Omega)$	$V_{GS} = 10 \text{ V}$	2.2		
Q _g max. (nC)	31			
Q _{gs} (nC)	4.6			
Q _{gd} (nC)	17			
Configuration	Single			

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRFBC30PbF		
Lead (Pb)-free and halogen-free	IRFBC30PbF-BE3		

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	V
Gate-source voltage			V_{GS}	± 20	T v
Continuous drain current	\/ at 10 \/	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	1	3.6	А
	V _{GS} at 10 V	T _C = 100 °C	I _D	2.3	
Pulsed drain current ^a			I _{DM}	14	
Linear derating factor			0.59	W/°C	
Single pulse avalanche energy b		E _{AS}	290	mJ	
Repetitive avalanche current a			I _{AR}	3.6	Α
Repetitive avalanche energy ^a			E _{AR}	7.4	mJ
Maximum power dissipation	T _C = 25 °C		P_D	74	W
Peak diode recovery dV/dt ^c		dV/dt	3.0	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	For 10 s 300		300		
Mounting torque	6-32 or M3 screw			10	lbf ⋅ in
				1.1	N⋅m

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 41 mH, R_g = 25 Ω , I_{AS} = 3.6 A (see fig. 12)
- c. $I_{SD} \le 3.6$ A, $dI/dt \le 60$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C
- d. 1.6 mm from case



IRFBC30

Vishay Siliconix

www.vishay.com

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	=	62		
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	1.7		

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0$	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.62	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = \	/ _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	Vo	_{aS} = ± 20 V	-	-	± 100	nA
7	,	V _{DS} = 600 V, V _{GS} = 0 V		-	-	100	μΑ
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}, \text{ V}$	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.2 A ^b	-	-	2.2	Ω
Forward transconductance	9 _{fs}	V _{DS} = 10	00 V, I _D = 2.2 A ^b	2.5	-	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	660	-	pF
Output capacitance	C _{oss}			-	86	-	
Reverse transfer capacitance	C _{rss}			-	19	-	
Total gate charge	Qg	V _{GS} = 10 V	I _D = 3.6 A, V _{DS} = 360 V, see fig. 6 and 13 ^b	-	-	31	nC
Gate-source charge	Q _{gs}			-	-	4.6	
Gate-drain charge	Q_{gd}		occ lig. o and ro	-	-	17	
Turn-on delay time	t _{d(on)}	$V_{DD} = 300 \text{ V, } I_D = 3.6 \text{ A ,}$ $R_g = 12 \Omega, R_D = 82 \Omega, \text{ see fig. } 10^\text{ b}$		-	11	-	ns
Rise time	t _r			-	13	-	
Turn-off delay time	t _{d(off)}			-	35	-	
Fall time	t _f			-	14	-	
Gate input resistance	R _g	f = 1 M	f = 1 MHz, open drain		-	4.9	Ω
Internal drain inductance	L _D	6 mm (0.25")	Between lead, 6 mm (0.25") from		4.5	-	الم
Internal source inductance	L _S	package and center of die contact		-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	showing th	MOSFET symbol showing the		-	3.6	_
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	14	A
Body diode voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 3.6 \text{A}, V_{GS} = 0 \text{V}^{ \text{b}}$		-	-	1.6	V
Body diode reverse recovery time	t _{rr}	- T _J = 25 °C, I _F = 3.6 A, dl/dt = 100 A/μs b		-	370	810	ns
Body diode reverse recovery charge	Q _{rr}			-	2.0	4.2	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

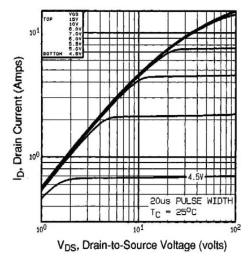


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

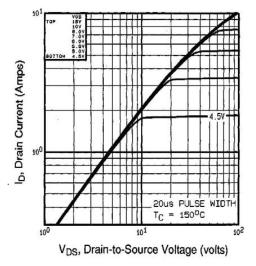


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

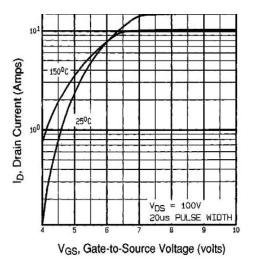


Fig. 3 - Typical Transfer Characteristics

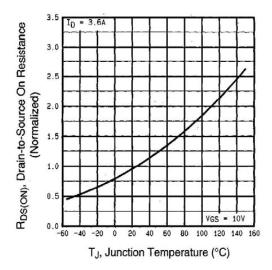


Fig. 4 - Normalized On-Resistance vs. Temperature

Vishay Siliconix

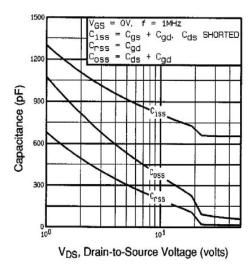


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

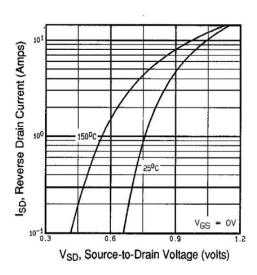


Fig. 7 - Typical Source-Drain Diode Forward Voltage

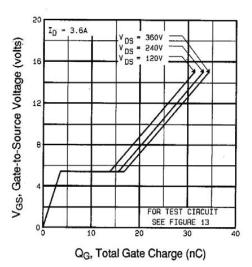


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

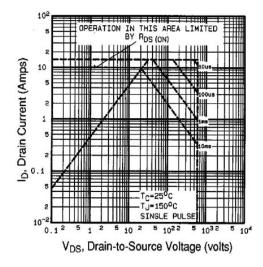


Fig. 8 - Maximum Safe Operating Area

Vishay Siliconix

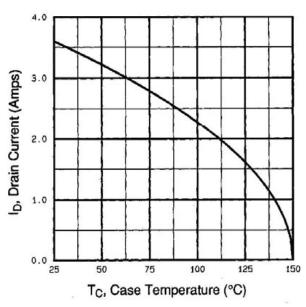


Fig. 9 - Maximum Drain Current vs. Case Temperature

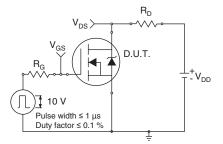


Fig. 10a - Switching Time Test Circuit

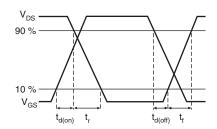


Fig. 10b - Switching Time Waveforms

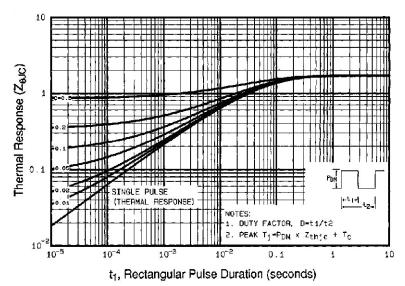


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

Vishay Siliconix

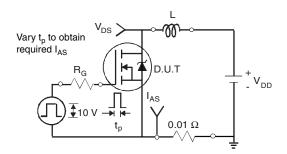


Fig. 12a - Unclamped Inductive Test Circuit

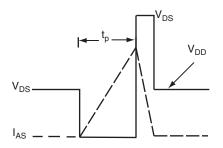


Fig. 12b - Unclamped Inductive Waveforms

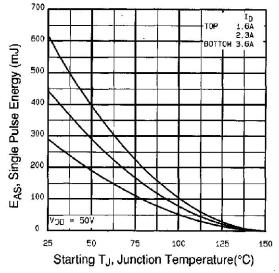


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

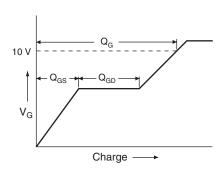


Fig. 13a - Basic Gate Charge Waveform

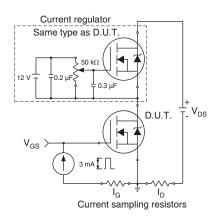
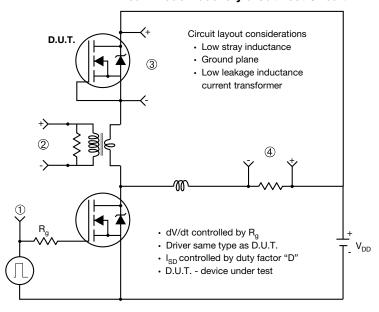


Fig. 13b - Gate Charge Test Circuit



www.vishay.com Vishay Siliconix

Peak Diode Recovery dV/dt Test Circuit



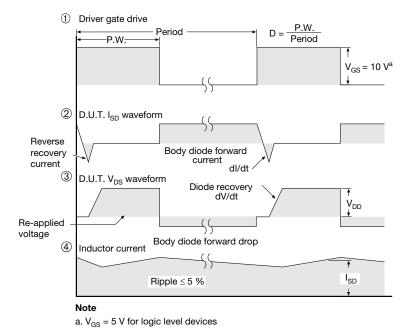


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91110.



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.



OUR CERTIFICATE

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

















Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com